

Replacing the Cypress CY14V101LA-BA45 nvSRAM with Everspin's MR0D08BMAxx MRAM

GENERAL CONSIDERATIONS for REPLACING nvSRAM with MRAM

Every write with an Everspin MRAM is instantly non-volatile for at least 20 years. There is no transfer of data from a volatile to a non-volatile memory cell, no external capacitors or back up batteries. The elimination of external components, highly reliable data retention, and 45ns SRAM compatible READ/WRITE Access times make the Everspin MRAM a viable candidate for replacing the Cypress CY14V101LA-BA45 nvSRAM without compromising system performance.

EVERSPIN MRAM MEMORY

Everspin is the global leader in commercially viable MRAM technology and Everspin MRAM products are present in hundreds of applications demanding high-speed, reliable, non-volatile memory.

MR0D08B COMPARISON TO CY14V101LA

The Everspin MRAM solution provides:

- Always Non-Volatile. No Unreliable Capacitor Dependent Backup Cycles
- No Vcap or Vbatt required
- Immediate (<1ns) Power-off with no loss of data
- No complex Software STORE/RECALL routines
- Fast Start-up time (2ms vs. 20ms)
- Unlimited Read and Write cycles - No Wear-out Concerns
- 20-Year Data Retention with No Cycling Dependence
- Fewer components means smaller design footprint and lower total BOM cost
- Directly replaces the Cypress nvSRAM

COMPATIBILITY

The Everspin MR0D08BBMA45 MRAM memory is pin and timing compatible with the Cypress CY14V101LA-BA45 nvSRAM.

TIMING COMPATIBILITY

Both Everspin MRAM and nvSRAM have standard, compatible asynchronous SRAM timing. The MRAM however, retains data even at power off for an indefinite period of time and over temperature cycling. With a 45 ns read/write cycle time, the MRAM is compatible with similar nvSRAM speed grade options.

It is important to note that the Everspin MR0D08Bxxx device requires a minimum of 12ns hold time from Write Enable (and Chip Enable) high to Address invalid (Please see T_{WHAX} and T_{EHAX} in the MR0D08B data sheet available [here.](#)) Most microprocessors can accommodate this Hold time.

PIN COMPATIBILITY

- 1Mb organized in the 128Kx8 configuration
- 3.3 volt nominal operation
- Standard SRAM parallel address pins (A0-16)
- Standard byte-wide, bidirectional data pins (DQ0-7)
- Standard control signals (/E, /W, /G)

The MR0D08B does not require an external capacitor and the other associated passive components required by the CY14V101LA-BA45 device.

The primary differences between the Cypress and Everspin devices are the two pins on the nvSRAM labeled: V_{CAP} and /HSB. These pins are used to support the nvSRAM backup cycle and are not required for operation of the MRAM.

V_{CAP} pin

A capacitor is required on the V_{CAP} ball (E3) on the nvSRAM. Everspin assigns a “Do not connect” (DC) to the corresponding ball on the MRAM. When replacing the Cypress nvSRAM with the Everspin MRAM, it is recommended that this ball be left floating. If a capacitor is connected to this ball, it is expected to have no effect on MRAM operation (assuming no initial charge on the capacitor).

/HSB pin

The /HSB ball (G2) of the nvSRAM is used to either initiate a Hardware Store or indicate a Hardware Store is in process. The corresponding ball on the MRAM is labeled as “Not connected (NC)”. Therefore, a host processor should not expect this I/O to be asserted in either direction (high or low) by the MRAM.

PINOUT DIFFERENCES

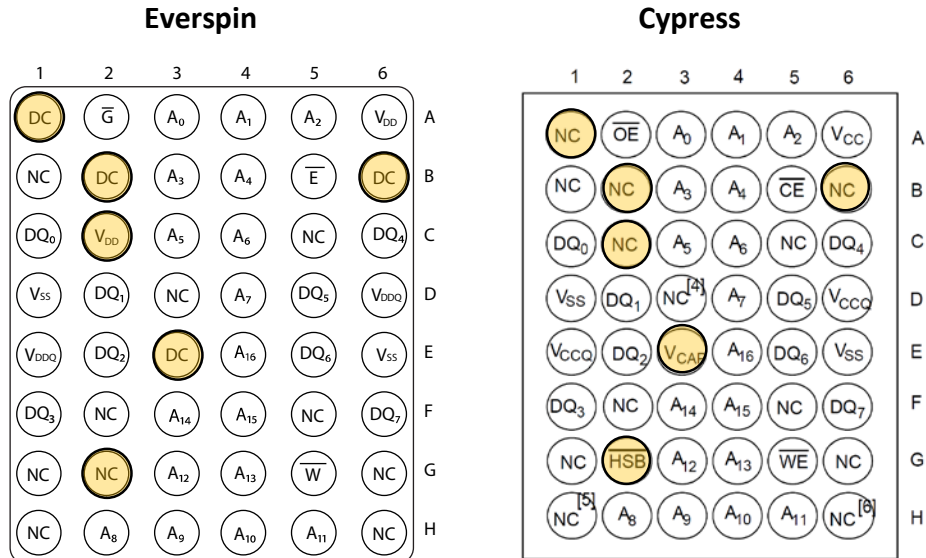


Figure 1 - Pin Function Comparison Between MRAM and nvSRAM, 48 FBGA Package

Ball #	Everspin	Cypress	Everspin Connection	Everspin Comments
A1	DC	NC	Do not connect	Internally pulled down. Prefer to float but okay to tie to VIH or VIL
B2	DC	NC	Do not connect	Internally pulled down. Prefer to float but okay to tie to VIH or VIL
B6	DC	NC	Do not connect	Prefer to float but okay to tie to VIH or VIL
C2	Vdd	NC	Vdd	This pin is redundant with pin A6 and does not necessarily need to be connected to Vdd (see information below)
E3	DC	VCap	Do not connect	Must be kept at a Steady State. Prefer floating or tied to Vss to minimize current draw.
G2	NC	HSB_	No connect	Prefer to float but okay to tie to VIH or VIL

PACKAGE DIMENSIONS

The Everspin FBGA device is drop in compatible with the corresponding Cypress equivalents. However, see figures 2 and 3 to understand the package dimension differences between the Cypress and Everspin FBGA packages. Make special note of the package dimension differences requiring different mechanical "Keep out" areas for these packages.

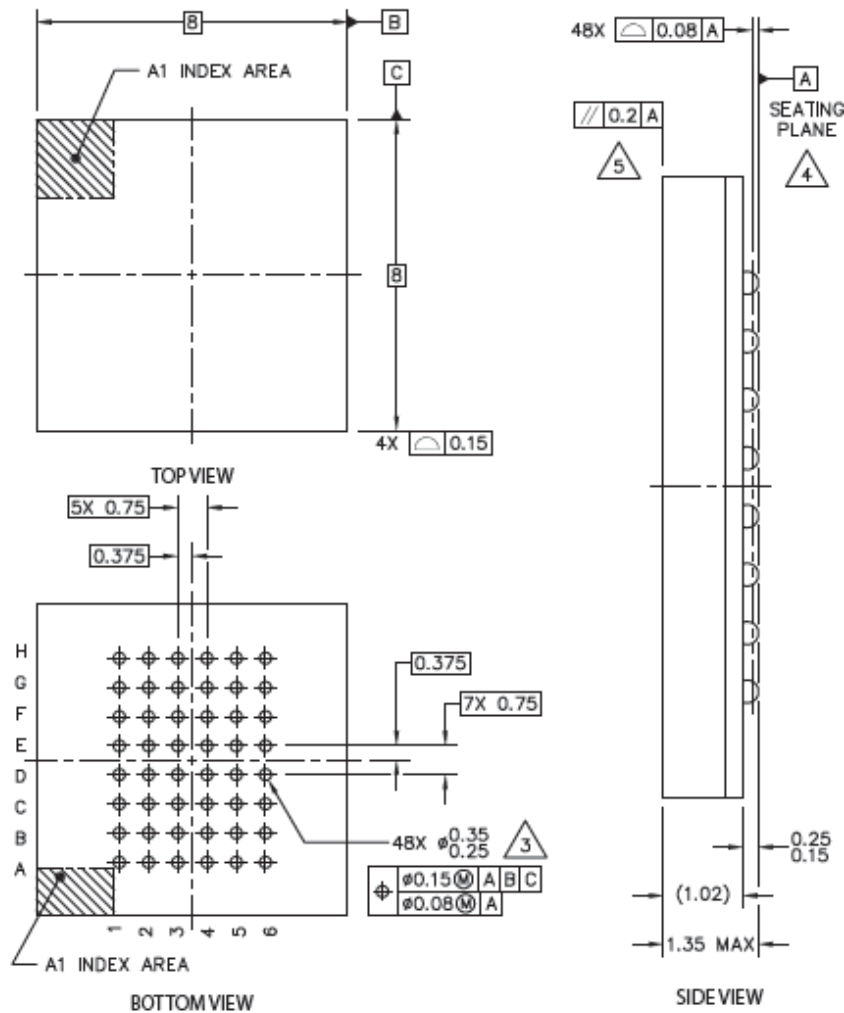


Figure 2 - Everspin FBGA Package Dimensions

Replacing the Cypress CY14V101LA-BA45 nvSRAM with Everspin's MR0D08BMAxx MRAM

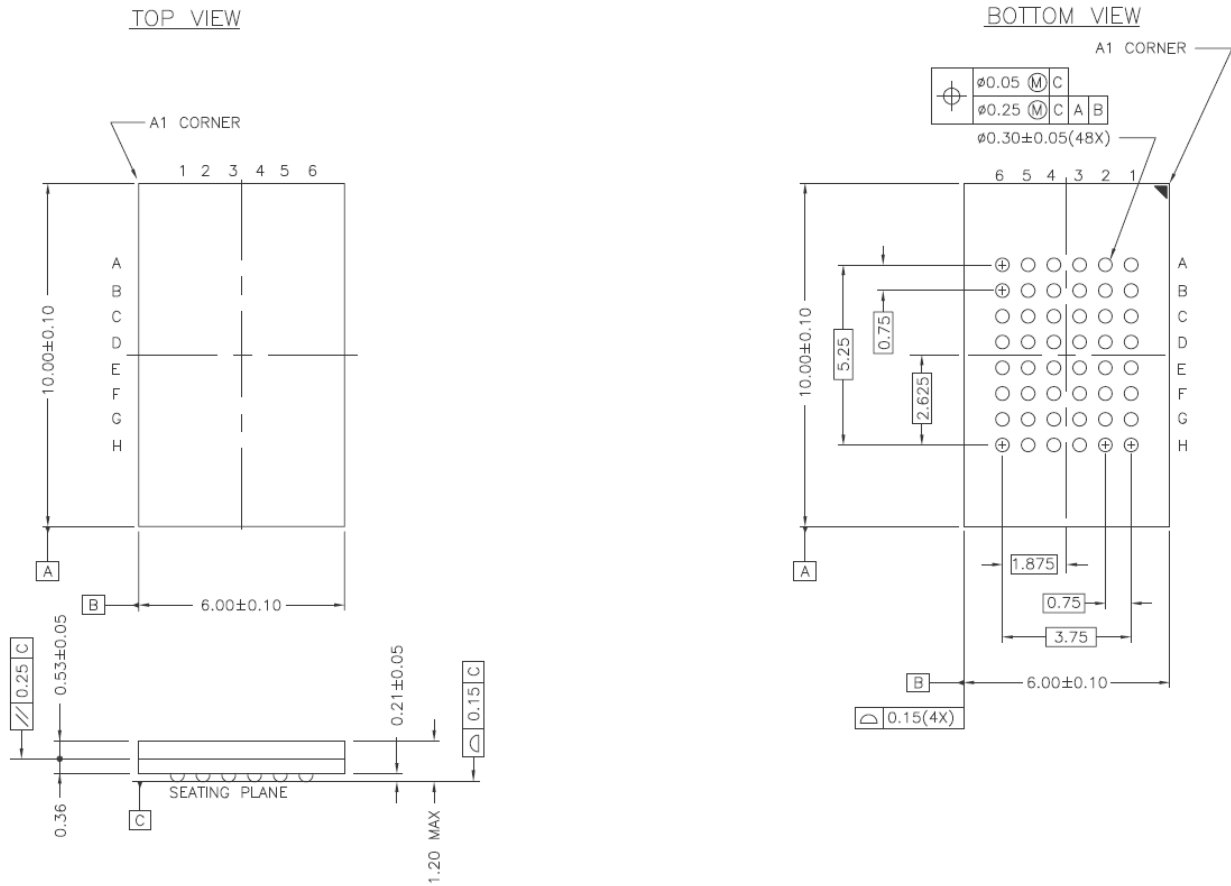


Figure 3 - Cypress FBGA Package Dimensions

OTHER REPLACEMENT DESIGN CONSIDERATIONS

HSB SOFTWARE

Due to its persistence, there is no power monitoring requirement for the Everspin MRAM as is the case with the nvSRAM. Therefore, initiating or monitoring Hardware Stores, Restores and associated software routines are unnecessary and can be eliminated.

SIMPLIFIED POWER CYCLING

When power is removed from the MRAM, data remains indefinitely over time and temperature until re-programmed. This feature, unique to MRAM, allows for Duty Cycle Power control enabling the user to reduce their overall power consumption without the concern of wear-out.

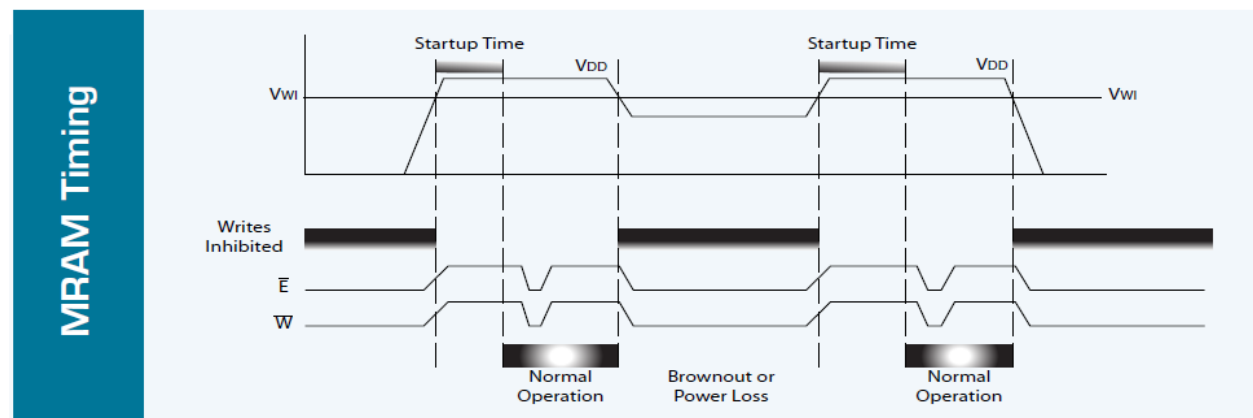
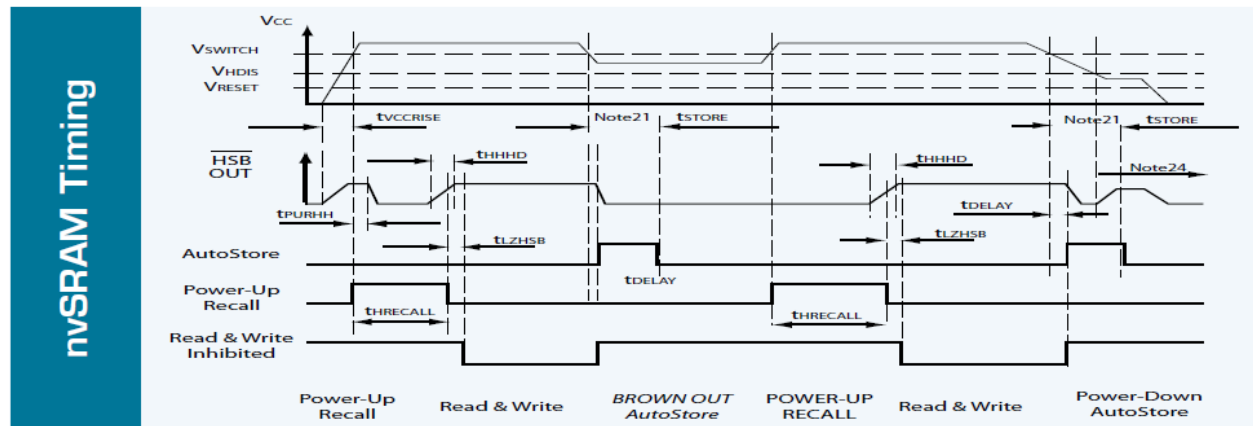
MRAM requires control signals /E and /W to track the power supply during power-up and be held high for a 2 ms start-up period a much shorter power-up requirement than the nvSRAM. When power fails, the Everspin MRAM simply inhibits write operations and no special power down timing considerations are needed since data is always non-volatile.

The nvSRAM device requires the /WE signal to track the power supply during power-up and be held high during the power-up recall period of 20 ms. The nvSRAM must sense the power failure, decouple the power supply from its backup capacitor, wait for any SRAM operations to complete, and then perform a parallel write to the EEPROM storage element during the 8 ms period after power has failed. This sequence is complicated by the fact that power falls at various ramp rates and in some cases bounces above and below the power supply threshold (brown outs) in rapid succession. Thus raising concerns about reliability of the backup storage cycle under all system power conditions including some that cannot easily be simulated or tested.

Additionally, there may be concern with the wear-out of nvSRAM EEPROM storage element which is limited to 1 million Program/Erase cycles. Everspin MRAM supports unlimited read, write, and power cycles. There are no wear-out concerns with MR0D08Bxxx.

POWER-UP SEQUENCING

Both MRAM and nvSRAM will operate from a standard +3.3 volt power supply with +/-10% power supply range. Both MRAM and nvSRAM have similar standby and active operating currents, however, the "Start-up" time for the MRAM is 2ms vs. 20ms for the nvSRAM. Proper decoupling capacitors should be used to assure reliable operation.



RELIABILITY CONSIDERATIONS FOR COMPARISON

CY14V101LA-BA45 uses conventional trapped charge technology for non-volatile storage. Data can leak away as wear-out results from temperature and excessive write cycles. Engineers must carefully design systems using nvSRAM to avoid exceeding the non-volatile write limitation of 1million cycles.

Everspin MRAM will provide the most cost effective non-volatile RAM solution. The nvSRAM is constructed by combining a standard 6-transistor SRAM with a non-volatile EEPROM storage element in every cell. The total cell complexity is 12-transistors. MR0D08Bxxx is built using a much simpler 1-transistor, 1-magnetic tunnel junction cell. The simple Everspin MRAM cell leads to improved manufacturing efficiency and increased reliability.

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The reliability of an nvSRAM is dependent upon not only the memory chip but also the quality of the external V_{CAP} capacitor. Careful capacitor selection is necessary to assure reliable power sequencing.

MRAM uses magnetic tunnel junction technology for non-volatile storage. Data does not leak away at high temperature and there is no wear-out mechanism to limit the number of read, write, or power cycles. Data retention is better than 20 years at 125 °C.

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